June 2003

FDS6670A

FAIRCHILD SEMICONDUCTOR

Single N-Channel, Logic Level, PowerTrench^o MOSFET

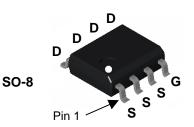
General Description

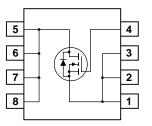
This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- 13 A, 30 V. $\begin{array}{l} R_{DS(ON)} = 8 \; m\Omega \; @ \; V_{GS} = 10 \; V \\ R_{DS(ON)} = 10 \; m\Omega \; @ \; V_{GS} = 4.5 \; V \end{array}$
- Fast switching speed
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

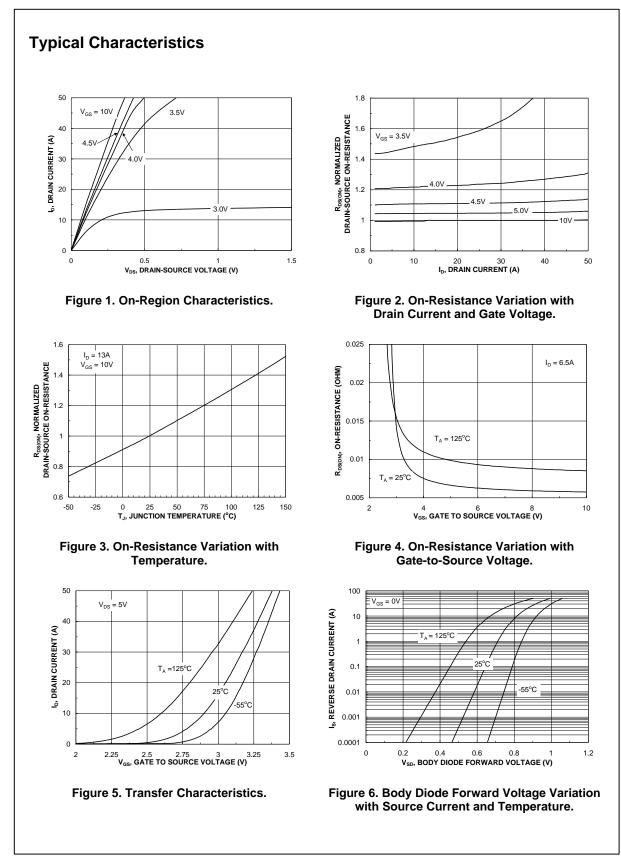
Symbol		Parameter		Ratings	Units	
V _{DSS}	Drain-Source	ce Voltage		30	V	
V _{GSS}	Gate-Sourc	e Voltage		±20	V	
I _D	Drain Curre	nt – Continuous	(Note 1a)	13	А	
		- Pulsed		50		
P _D	Power Diss	ipation for Single Operation	(Note 1a)	2.5	W	
			(Note 1b)	1.0		
т <u>т</u>	Onersting	ad Otomore, lunation Tomore	tuna Danana	EE to 11EO	°C	
T _J , T _{STG}	Operating a	nd Storage Junction Tempera	ture Range	-55 to +150	10	
Therma	al Charac			-55 10 + 150	°C/W	
Therma R _{0JA}	al Charac Thermal Re	teristics	(Note 1a)			
	Al Charac Thermal Re Thermal Re	teristics sistance, Junction-to-Ambient	(Note 1a)	50		
Therma R _{θJA} R _{θJA} R _{θJC}	Al Charac Thermal Re Thermal Re Thermal Re	teristics esistance, Junction-to-Ambient esistance, Junction-to-Ambient	(Note 1a) (Note 1b) (Note 1)	50 125		
Therma R _{θJA} R _{θJA} R _{θJC} Packag	Al Charac Thermal Re Thermal Re Thermal Re	teristics sistance, Junction-to-Ambient sistance, Junction-to-Ambient sistance, Junction-to-Case g and Ordering Infe	(Note 1a) (Note 1b) (Note 1)	50 125		

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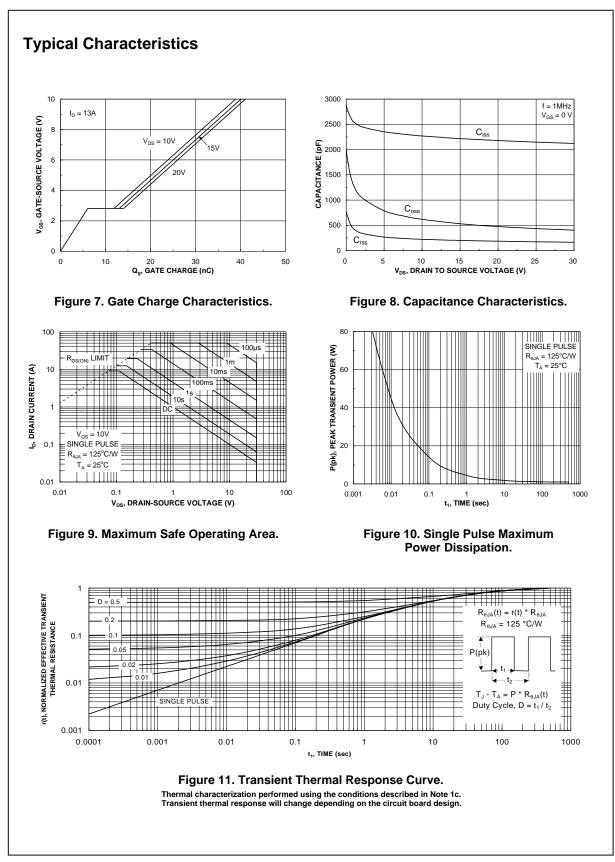
	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		26		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
		$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			10	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	1	1.8	3	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$		-5.3		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = 10 \text{ V}, \qquad I_D = 13 \text{ A}$		6	8	mΩ
	On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 10.5 \text{ A}$		7.2 8.5	10 14	
1	On State Drain Current	V_{GS} = 10 V, I_D = 13 A, T_J =125°C	E0	0.0	14	•
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	50	FF		A S
g _{FS}	Forward Transconductance	$V_{DS} = 15 \text{ V}, \qquad I_D = 13 \text{ A}$		55		3
	Characteristics		-	1		1
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		2220		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		535		pF
Crss	Reverse Transfer Capacitance			200		pF
R _G	Gate Resistance	V_{GS} = 15 mV, f = 1.0 MHz		1.7		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD}=10\;V,\qquad I_{D}=1\;A,$		11	19	ns
tr	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		13	24	ns
t _{d(off)}	Turn–Off Delay Time			40	64	ns
t _f	Turn–Off Fall Time			13	24	ns
Qg	Total Gate Charge	$V_{DS} = 15 V, I_D = 13 A,$		21	30	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 5 V$		6		nC
Q _{gd}	Gate-Drain Charge			7		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source	Diode Forward Current			2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V,$ $I_{S} = 2.1 \ A \ (Note 2)$		0.7	1.2	V
Diode Reverse Recovery Time	$I_F = 13 \text{ A}, \qquad d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$		31		nS	
Q _{rr}	Diode Reverse Recovery Charge			21		nC

2 Test: Pulse Width < 300µs, Duty Cycle < 2.0%



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FDS6670A Rev F (W)



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